RoHS



Vishay General Semiconductor

Standard Avalanche SMD Rectifier



DO-214AC (SMA)

PRIMARY CHARACTERISTICS						
I _{F(AV)}	1.5 A					
V_{RRM}	200 V to 1600 V					
I _{FSM}	30 A					
I _R	1.0 μA					
V _F	1.15 V					
E _R	20 mJ					
T_J max.	150 °C					

FEATURES

- · Low profile package
- Ideal for automated placement
- · Controlled avalanche characteristics
- Glass passivated junction
- · Low reverse current
- · High surge current capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS compliant, commercial grade Base P/NHE3 - RoHS compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Note

· BYG10Y for commercial grade only

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Device marking code		BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	
Maximum repetitive peak reverse voltage	V _{RRM}	V _{RRM} 200 400 600 800 1000 1600		1600	V			
Average forward current	I _{F(AV)}	1.5					Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	30					Α	
Pulse energy in avalanche mode, non repetitive (inductive load switch off) I _{(BR)R} = 1 A, T _J = 25 °C (for BYG10D thru BYG10M)	E _R	20					mJ	
Operating junction and storage temperature range	T _J , T _{STG}	T _{STG} - 55 to + 150					°C	





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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Maximum	I _F = 1 A	_		1.1					V	
instantaneous forward voltage ⁽¹⁾	I _F = 1.5 A	T _J = 25 °C	V _F	1.15						
Maximum DC	$V_R = V_{RRM}$	T _J = 25 °C	T _J = 25 °C 1					μA		
reverse current	VR - VRRM	T _J = 100 °C	I _R	10					μΛ	
Maximum reverse recovery time	$I_F = 0.5 A, I_R$ $I_{rr} = 0.25 A$	= 1.0 A,	t _{rr}	4			μs			

Note

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL BYG10D BYG10G BYG10J BYG10K BYG10M BYG10V					BYG10Y	UNIT	
Typical thermal resistance, junction to lead	$R_{\theta JL}$	25						°C/W
	R _{0JA} (1)	150						
Typical thermal resistance, junction to ambient	R _{0JA} (2)	125						°C/W
	R _{0JA} (3)	100						

Notes

- (1) Mounted on epoxy-glass hard tissue
- $^{(2)}$ Mounted on epoxy-glass hard tissue, 50 mm 2 35 μ m Cu
- $^{(3)}$ Mounted on Al-oxide-ceramic (Al $_2$ O $_3$), 50 mm 2 35 μ m Cu

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
BYG10D-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel				
BYG10D-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel				
BYG10DHE3/TR (1)	0.064	TR	1800	7" diameter plastic tape and reel				
BYG10DHE3/TR3 (1)	0.064	TR3	7500	13" diameter plastic tape and reel				

Note

(1) AEC-Q101 qualified

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RATINGS AND CHARACTERISTICS CURVES

(T_A = 25 °C unless otherwise noted)

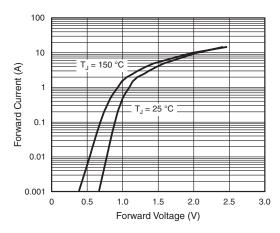


Fig. 1 - Forward Current vs. Forward Voltage

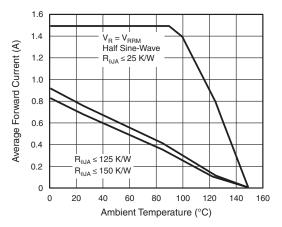


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

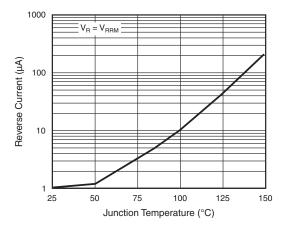


Fig. 3 - Reverse Current vs. Junction Temperature

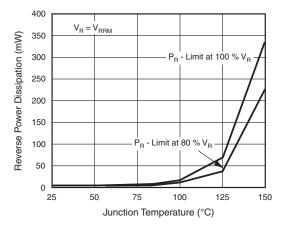


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

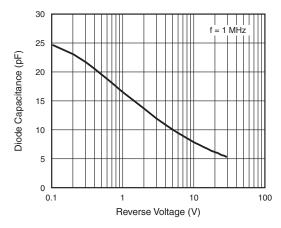


Fig. 5 - Diode Capacitance vs. Reverse Voltage

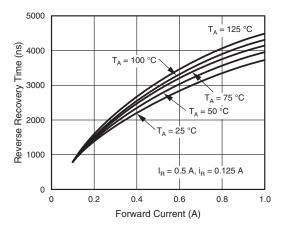


Fig. 6 - Reverse Recovery Time vs. Forward Current



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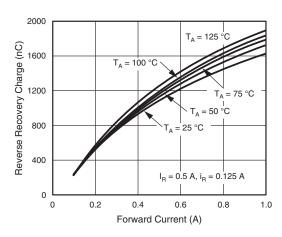
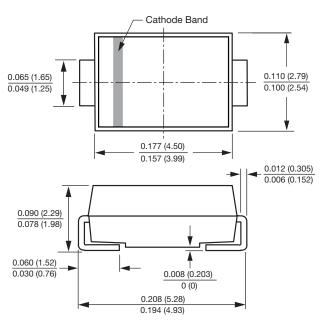


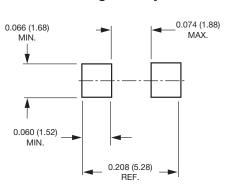
Fig. 7 - Reverse Recovery Charge vs. Forward Current

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

DO-214AC (SMA)



Mounting Pad Layout





Legal Disclaimer Notice

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Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.